

**Features**

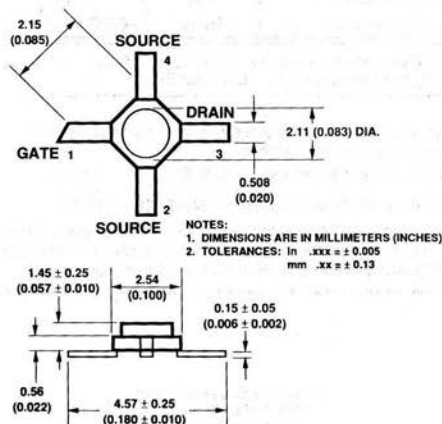
- **Low Noise Figure: 1.2 dB typical at 12 GHz**
- **High Associated Gain: 9.5 dB typical at 12 GHz**
- **High Output Power: 17.5 dBm typical P<sub>1dB</sub> at 12 GHz**
- **Cost Effective Ceramic Microstrip Package**
- **Tape-and-Reel Packaging Option Available<sup>2</sup>**

**Description**

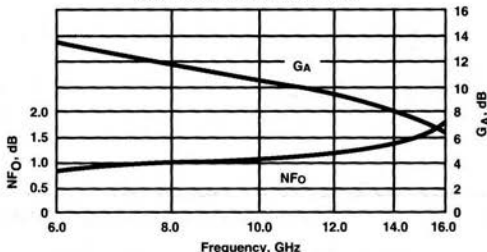
The ATF-13136 is a high performance gallium arsenide Schottky-barrier-gate field effect transistor housed in a cost effective microstrip package. Its premium noise figure makes this device appropriate for use in the first stage of low noise amplifiers operating in the 2-16 GHz frequency range.

This GaAs FET device has a nominal 0.3 micron gate length with a total gate periphery of 250 microns. Proven gold based metallization systems and nitride passivation assure a rugged, reliable device.

**36 micro-X Package<sup>1</sup>**



**OPTIMUM NOISE FIGURE AND ASSOCIATED GAIN vs. FREQUENCY**  
 V<sub>DS</sub> = 2.5 V, I<sub>DS</sub> = 20 mA, T<sub>A</sub> = 25°C



**Noise Parameters: V<sub>DS</sub> = 3 V, I<sub>DS</sub> = 20 mA**

Freq. GHz	NF <sub>0</sub> dB	Gamma Opt Mag	Ang	Rn/50
4.0	0.5	.58	87	.22
6.0	0.8	.47	130	.18
8.0	1.0	.37	-163	.17
12.0	1.2	.47	-65	.80
14.0	1.4	.52	-15	1.20

**Electrical Specifications, T<sub>A</sub> = 25°C**

Symbol	Parameters and Test Conditions	Units	Min.	Typ.	Max.
NF <sub>0</sub>	Optimum Noise Figure: V <sub>DS</sub> = 2.5 V, I <sub>DS</sub> = 15 - 30 mA	f = 8.0 GHz f = 12.0 GHz f = 14.0 GHz	dB	1.0 1.2 1.4	1.4
G <sub>A</sub>	Gain @ NF <sub>0</sub> : V <sub>DS</sub> = 2.5 V, I <sub>DS</sub> = 15 - 30 mA	f = 8.0 GHz f = 12.0 GHz f = 14.0 GHz	dB	8.5 11.5 9.5 8.0	
P <sub>1dB</sub>	Output Power @ 1 dB Gain Compression: V <sub>DS</sub> = 4 V, I <sub>DS</sub> = 40 mA	f = 12.0 GHz	dBm	17.5	
G <sub>1dB</sub>	1dB Compressed Gain: V <sub>DS</sub> = 4 V, I <sub>DS</sub> = 40 mA	f = 12.0 GHz	dB	8.5	
g <sub>m</sub>	Transconductance: V <sub>DS</sub> = 2.5 V, V <sub>GS</sub> = 0 V		mmho	25	55
I <sub>DSS</sub>	Saturated Drain Current: V <sub>DS</sub> = 2.5 V, V <sub>GS</sub> = 0 V		mA	40	50
V <sub>P</sub>	Pinchoff Voltage: V <sub>DS</sub> = 2.5 V, I <sub>DS</sub> = 1 mA		V	-4.0	-1.5

Notes: 1. Long leaded 35 package available upon request.  
 2. Refer to PACKAGING section "Tape-and-Reel Packaging for Surface Mount Semiconductors".

**Absolute Maximum Ratings**

Parameter	Symbol	Absolute Maximum <sup>1</sup>
Drain-Source Voltage	V <sub>DS</sub>	+5 V
Gate-Source Voltage	V <sub>GS</sub>	-4 V
Drain Current	I <sub>DS</sub>	I <sub>DSS</sub>
Power Dissipation <sup>2,3</sup>	P <sub>T</sub>	225 mW
Channel Temperature	T <sub>CH</sub>	175°C
Storage Temperature <sup>4</sup>	T <sub>STG</sub>	-65°C to +175°C

Thermal Resistance:  $\theta_{jc} = 400^\circ\text{C/W}$ ; T<sub>CH</sub> = 150°C  
Liquid Crystal Measurement; 1  $\mu\text{m}$  Spot Size<sup>5</sup>

**Notes:**

1. Operation of this device above any one of these parameters may cause permanent damage.
2. Case Temperature = 25°C.
3. Derate at 2.5 mW/°C for T<sub>CASE</sub> > 85°C.
4. Storage above +150°C may tarnish the leads of this package making it difficult to solder into a circuit. After a device has been soldered into a circuit, it may be safely stored up to 175°C.
5. The small spot size of this technique results in a higher, though more accurate determination of  $\theta_{jc}$  than do alternate methods. See MEASUREMENTS section for more information.

**Part Number Ordering Information**

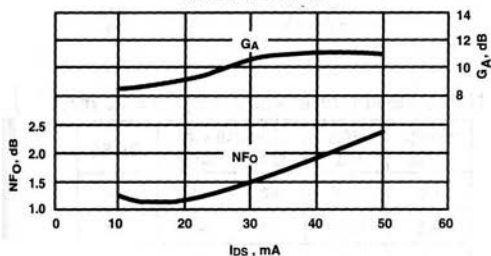
Part Number	Devices Per Reel	Reel Size
ATF-13136-TR1	1000	7"
ATF-13136-TR2	4000	13"
ATF-13136-STR	1	STRIP

For more information, see "Tape and Reel Packaging for Semiconductor Devices", page 14-14.

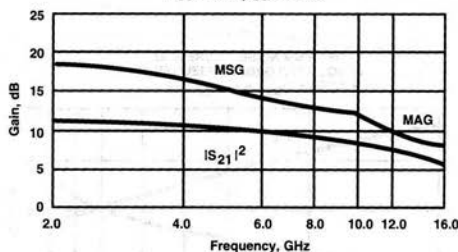
**Typical Performance, T<sub>A</sub> = 25°C**

(unless otherwise noted)

OPTIMUM NOISE FIGURE AND ASSOCIATED GAIN vs. I<sub>DS</sub>  
V<sub>DS</sub> = 2.5 V, f = 12.0 GHz



INSERTION POWER GAIN, MAXIMUM AVAILABLE GAIN AND MAXIMUM STABLE GAIN vs. FREQUENCY  
V<sub>DS</sub> = 2.5 V, I<sub>DS</sub> = 20 mA



**Typical Scattering Parameters: Common Source, Z<sub>0</sub> = 50  $\Omega$**

T<sub>A</sub> = 25°C, V<sub>DS</sub> = 2.5 V, I<sub>DS</sub> = 20 mA

Freq. GHz	S <sub>11</sub>		S <sub>21</sub>			S <sub>12</sub>			S <sub>22</sub>	
	Mag	Ang	dB	Mag	Ang	dB	Mag	Ang	Mag	Ang
2.0	.95	-42	11.2	3.65	134	-26.7	.046	62	.56	-37
3.0	.87	-65	10.7	3.43	112	-24.2	.062	40	.53	-47
4.0	.84	-85	10.3	3.28	93	-22.3	.077	31	.53	-54
5.0	.78	-104	10.1	3.21	73	-20.3	.097	18	.48	-62
6.0	.69	-128	10.4	3.30	52	-18.6	.117	7	.43	-76
7.0	.59	-163	10.4	3.32	27	-17.3	.137	-12	.35	-95
8.0	.54	157	9.8	3.10	2	-17.0	.142	-27	.26	-110
9.0	.55	121	9.2	2.89	-19	-16.3	.153	-43	.15	-119
10.0	.54	93	8.7	2.71	-41	-16.0	.159	-58	.07	-142
11.0	.56	64	8.1	2.54	-61	-16.2	.155	-73	.06	92
12.0	.61	37	7.4	2.34	-84	-16.8	.144	-89	.15	46
13.0	.65	19	6.8	2.18	-102	-17.6	.132	-100	.18	23
14.0	.65	7	6.4	2.09	-120	-18.0	.126	-114	.19	-2
15.0	.67	-6	5.9	1.98	-139	-18.2	.123	-119	.16	-27
16.0	.68	-25	5.3	1.84	-170	-18.4	.120	-134	.13	-30

A model for this device is available in the DEVICE MODELS section.